

Appln No. 10/760,274
Amdt. Dated February 6, 2006
Response to Office Action of November 22, 2005

2

Amendments to the Specification:**The Paragraph beginning at Page 8, lines 28-29, is to be amended as follows:**

The ink jet printhead chip 52 (see Fig. 6) includes a silicon wafer substrate ~~80~~8015. 0.35 Micron 1 P4M 12 volt CMOS microprocessing circuitry is positioned on the silicon wafer substrate 8015.